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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	20MHz
Connectivity	-
Peripherals	Brown-out Detect/Reset, POR, WDT
Number of I/O	11
Program Memory Size	3.5KB (2K x 14)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	128 x 8
Voltage - Supply (Vcc/Vdd)	2V ~ 5V
Data Converters	A/D 8x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	14-SOIC (0.154", 3.90mm Width)
Supplier Device Package	14-SOIC
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16hv616-i-sl

TABLE 1-1: PIC16F610/16HV610 PINOUT DESCRIPTION

Name	Function	Input Type	Output Type	Description
RA0/C1IN+/ICSPDAT	RA0	TTL	CMOS	PORTA I/O with prog. pull-up and interrupt-on-change
	C1IN+	AN	—	Comparator C1 non-inverting input
	ICSPDAT	ST	CMOS	Serial Programming Data I/O
RA1/C12IN0-/ICSPCLK	RA1	TTL	CMOS	PORTA I/O with prog. pull-up and interrupt-on-change
	C12IN0-	AN	—	Comparators C1 and C2 inverting input
	ICSPCLK	ST	—	Serial Programming Clock
RA2/T0CKI/INT/C1OUT	RA2	ST	CMOS	PORTA I/O with prog. pull-up and interrupt-on-change
	T0CKI	ST	—	Timer0 clock input
	INT	ST	—	External Interrupt
	C1OUT	—	CMOS	Comparator C1 output
RA3/$\overline{MCLR}$/V_{PP}	RA3	TTL	—	PORTA input with interrupt-on-change
	$\overline{MCLR}$	ST	—	Master Clear w/internal pull-up
	V_{PP}	HV	—	Programming voltage
RA4/$\overline{T1G}$/OSC2/CLKOUT	RA4	TTL	CMOS	PORTA I/O with prog. pull-up and interrupt-on-change
	$\overline{T1G}$	ST	—	Timer1 gate (count enable)
	OSC2	—	XTAL	Crystal/Resonator
	CLKOUT	—	CMOS	$F_{OSC}/4$ output
RA5/T1CKI/OSC1/CLKIN	RA5	TTL	CMOS	PORTA I/O with prog. pull-up and interrupt-on-change
	T1CKI	ST	—	Timer1 clock input
	OSC1	XTAL	—	Crystal/Resonator
	CLKIN	ST	—	External clock input/RC oscillator connection
RC0/C2IN+	RC0	TTL	CMOS	PORTC I/O
	C2IN+	AN	—	Comparator C2 non-inverting input
RC1/C12IN1-	RC1	TTL	CMOS	PORTC I/O
	C12IN1-	AN	—	Comparators C1 and C2 inverting input
RC2/C12IN2-	RC2	TTL	CMOS	PORTC I/O
	C12IN2-	AN	—	Comparators C1 and C2 inverting input
RC3/C12IN3-	RC3	TTL	CMOS	PORTC I/O
	C12IN3-	AN	—	Comparators C1 and C2 inverting input
RC4/C2OUT	RC4	TTL	CMOS	PORTC I/O
	C2OUT	—	CMOS	Comparator C2 output
RC5	RC5	TTL	CMOS	PORTC I/O
V_{DD}	V_{DD}	Power	—	Positive supply
V_{SS}	V_{SS}	Power	—	Ground reference

Legend: AN = Analog input or output; CMOS = CMOS compatible input or output; HV = High Voltage
ST = Schmitt Trigger input with CMOS levels; TTL = TTL compatible input; XTAL = Crystal

2.2.2.4 PIE1 Register

The PIE1 register contains the peripheral interrupt enable bits, as shown in Register 2-4.

Note: Bit PEIE of the INTCON register must be set to enable any peripheral interrupt.

REGISTER 2-4: PIE1: PERIPHERAL INTERRUPT ENABLE REGISTER 1

U-0	R/W-0	R/W-0	R/W-0	R/W-0	U-0	R/W-0	R/W-0
—	ADIE(1)	CCP1IE(1)	C2IE	C1IE	—	TMR2IE(1)	TMR1IE
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7 **Unimplemented:** Read as '0'

bit 6 **ADIE:** A/D Converter (ADC) Interrupt Enable bit(1)
- 1 = Enables the ADC interrupt
- 0 = Disables the ADC interrupt

bit 5 **CCP1IE:** CCP1 Interrupt Enable bit(1)
- 1 = Enables the CCP1 interrupt
- 0 = Disables the CCP1 interrupt

bit 4 **C2IE:** Comparator C2 Interrupt Enable bit
- 1 = Enables the Comparator C2 interrupt
- 0 = Disables the Comparator C2 interrupt

bit 3 **C1IE:** Comparator C1 Interrupt Enable bit
- 1 = Enables the Comparator C1 interrupt
- 0 = Disables the Comparator C1 interrupt

bit 2 **Unimplemented:** Read as '0'

bit 1 **TMR2IE:** Timer2 to PR2 Match Interrupt Enable bit(1)
- 1 = Enables the Timer2 to PR2 match interrupt
- 0 = Disables the Timer2 to PR2 match interrupt

bit 0 **TMR1IE:** Timer1 Overflow Interrupt Enable bit
- 1 = Enables the Timer1 overflow interrupt
- 0 = Disables the Timer1 overflow interrupt

Note 1: PIC16F616/16HV616 only. PIC16F610/16HV610 unimplemented, read as '0'.

4.2 Additional Pin Functions

Every PORTA pin on the PIC16F610/616/16HV610/616 has an interrupt-on-change option and a weak pull-up option. The next three sections describe these functions.

4.2.1 ANSEL REGISTER

The ANSEL register is used to configure the Input mode of an I/O pin to analog. Setting the appropriate ANSEL bit high will cause all digital reads on the pin to be read as '0' and allow analog functions on the pin to operate correctly.

The state of the ANSEL bits has no affect on digital output functions. A pin with TRIS clear and ANSEL set will still operate as a digital output, but the Input mode will be analog. This can cause unexpected behavior when executing read-modify-write instructions on the affected port.

4.2.2 WEAK PULL-UPS

Each of the PORTA pins, except RA3, has an individually configurable internal weak pull-up. Control bits WPUAx enable or disable each pull-up. Refer to Register 4-4. Each weak pull-up is automatically turned off when the port pin is configured as an output. The pull-ups are disabled on a Power-on Reset by the RAPU bit of the OPTION register). A weak pull-up is automatically enabled for RA3 when configured as MCLR and disabled when RA3 is an input. There is no software control of the MCLR pull-up.

4.2.3 INTERRUPT-ON-CHANGE

Each PORTA pin is individually configurable as an interrupt-on-change pin. Control bits IOCAx enable or disable the interrupt function for each pin. Refer to Register 4-5. The interrupt-on-change is disabled on a Power-on Reset.

For enabled interrupt-on-change pins, the values are compared with the old value latched on the last read of PORTA. The 'mismatch' outputs of the last read are OR'd together to set the PORTA Change Interrupt Flag bit (RAIF) in the INTCON register (Register 2-3).

This interrupt can wake the device from Sleep. The user, in the Interrupt Service Routine, clears the interrupt by:

a) Any read or write of PORTA. This will end the mismatch condition, then,
b) Clear the flag bit RAIF.

A mismatch condition will continue to set flag bit RAIF. Reading PORTA will end the mismatch condition and allow flag bit RAIF to be cleared. The latch holding the last read value is not affected by a MCLR nor BOR Reset. After these resets, the RAIF flag will continue to be set if a mismatch is present.

Note:	If a change on the I/O pin should occur when any PORTA operation is being executed, then the RAIF interrupt flag may not get set.

REGISTER 4-3: ANSEL: ANALOG SELECT REGISTER

R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
ANS7	ANS6	ANS5	ANS4	ANS3(2)	ANS2(2)	ANS1	ANS0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-0 **ANS<7:0>**: Analog Select bits

Analog select between analog or digital function on pins AN<7:0>, respectively.

1 = Analog input. Pin is assigned as analog input(1).

0 = Digital I/O. Pin is assigned to port or special function.

Note 1: Setting a pin to an analog input automatically disables the digital input circuitry, weak pull-ups, and interrupt-on-change if available. The corresponding TRIS bit must be set to Input mode in order to allow external control of the voltage on the pin.

2: PIC16F616/HV616.

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5.0 TIMER0 MODULE

The Timer0 module is an 8-bit timer/counter with the following features:

- 8-bit timer/counter register (TMR0)
- 8-bit prescaler (shared with Watchdog Timer)
- Programmable internal or external clock source
- Programmable external clock edge selection
- Interrupt on overflow

Figure 5-1 is a block diagram of the Timer0 module.

5.1 Timer0 Operation

When used as a timer, the Timer0 module can be used as either an 8-bit timer or an 8-bit counter.

5.1.1 8-BIT TIMER MODE

When used as a timer, the Timer0 module will increment every instruction cycle (without prescaler). Timer mode is selected by clearing the T0CS bit of the OPTION register to '0'.

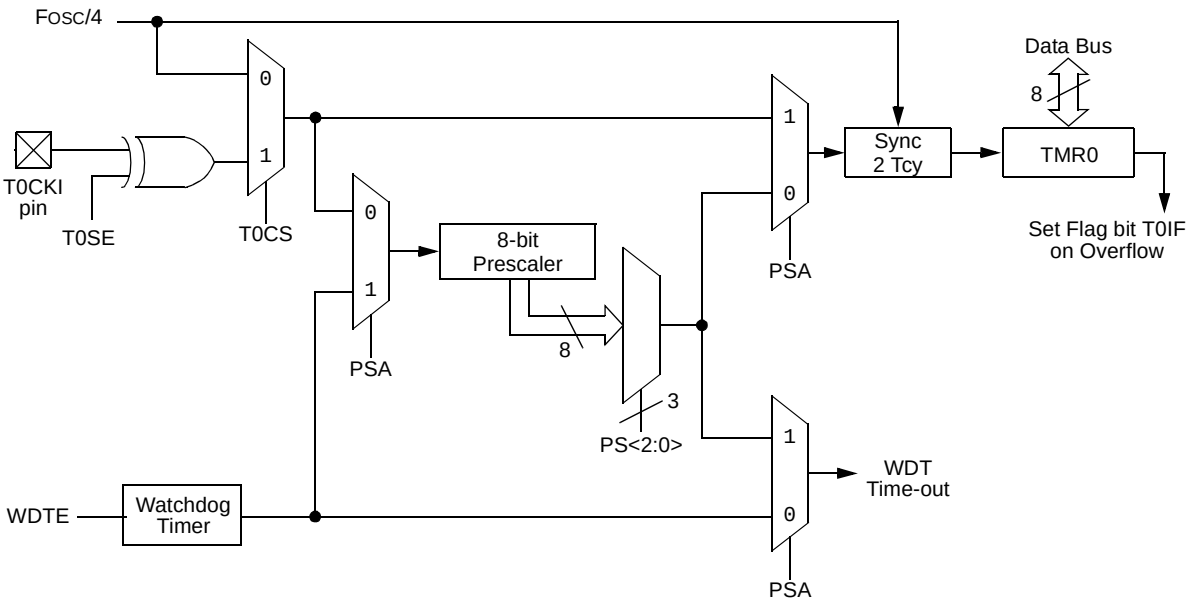
When TMR0 is written, the increment is inhibited for two instruction cycles immediately following the write.

Note:	The value written to the TMR0 register can be adjusted, in order to account for the two instruction cycle delay when TMR0 is written.

5.1.2 8-BIT COUNTER MODE

When used as a counter, the Timer0 module will increment on every rising or falling edge of the T0CKI pin. The incrementing edge is determined by the T0SE bit of the OPTION register. Counter mode is selected by setting the T0CS bit of the OPTION register to '1'.

FIGURE 5-1: BLOCK DIAGRAM OF THE TIMER0/WDT PRESCALER



Note 1: T0SE, T0CS, PSA, PS<2:0> are bits in the OPTION register.

2: WDTE bit is in the Configuration Word register.

5.1.3 SOFTWARE PROGRAMMABLE PRESCALER

A single software programmable prescaler is available for use with either Timer0 or the Watchdog Timer (WDT), but not both simultaneously. The prescaler assignment is controlled by the PSA bit of the OPTION register. To assign the prescaler to Timer0, the PSA bit must be cleared to a '0'.

There are 8 prescaler options for the Timer0 module ranging from 1:2 to 1:256. The prescale values are selectable via the PS<2:0> bits of the OPTION register. In order to have a 1:1 prescaler value for the Timer0 module, the prescaler must be assigned to the WDT module.

The prescaler is not readable or writable. When assigned to the Timer0 module, all instructions writing to the TMR0 register will clear the prescaler.

When the prescaler is assigned to WDT, a CLRWDT instruction will clear the prescaler along with the WDT.

5.1.3.1 Switching Prescaler Between Timer0 and WDT Modules

As a result of having the prescaler assigned to either Timer0 or the WDT, it is possible to generate an unintended device Reset when switching prescaler values. When changing the prescaler assignment from Timer0 to the WDT module, the instruction sequence shown in Example 5-1 must be executed.

EXAMPLE 5-1: CHANGING PRESCALER (TIMER0 → WDT)

```
BANKSEL  TMR0           ;
CLRWDT                  ;Clear WDT
CLRF     TMR0           ;Clear TMR0 and
                        ;prescaler
BANKSEL  OPTION_REG     ;
BSF      OPTION_REG,PSA ;Select WDT
CLRWDT          ;
                ;
MOVLW   b'11111000'     ;Mask prescaler
ANDWF   OPTION_REG,W    ;bits
IORLW   b'00000101'     ;Set WDT prescaler
MOVWF   OPTION_REG      ;to 1:32
```

When changing the prescaler assignment from the WDT to the Timer0 module, the following instruction sequence must be executed (see Example 5-2).

EXAMPLE 5-2: CHANGING PRESCALER (WDT → TIMER0)

```
CLRWDT                  ;Clear WDT and
                        ;prescaler
BANKSEL OPTION_REG      ;
MOVLW   b'11110000'     ;Mask TMR0 select and
ANDWF   OPTION_REG,W    ;prescaler bits
IORLW   b'00000011'     ;Set prescale to 1:16
MOVWF   OPTION_REG      ;
```

5.1.4 TIMER0 INTERRUPT

Timer0 will generate an interrupt when the TMR0 register overflows from FFh to 00h. The T0IF interrupt flag bit of the INTCON register is set every time the TMR0 register overflows, regardless of whether or not the Timer0 interrupt is enabled. The T0IF bit must be cleared in software. The Timer0 interrupt enable is the T0IE bit of the INTCON register.

Note:	The Timer0 interrupt cannot wake the processor from Sleep since the timer is frozen during Sleep.

5.1.5 USING TIMER0 WITH AN EXTERNAL CLOCK

When Timer0 is in Counter mode, the synchronization of the T0CKI input and the Timer0 register is accomplished by sampling the prescaler output on the Q2 and Q4 cycles of the internal phase clocks. Therefore, the high and low periods of the external clock source must meet the timing requirements as shown in **Section 15.0 "Electrical Specifications"**.

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TABLE 6-1: SUMMARY OF REGISTERS ASSOCIATED WITH TIMER1

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Value on all other Resets
CM2CON0	C2ON	C2OUT	C2OE	C2POL	—	C2R	C2CH1	C2CH0	0000 -000	0000 -000
CM2CON1	MC1OUT	MC2OUT	—	T1ACS	C1HYS	C2HYS	T1GSS	C2SYNC	00-0 0010	00-0 0010
INTCON	GIE	PEIE	T0IE	INTE	RAIE	T0IF	INTF	RAIF	0000 0000	0000 0000
PIE1	—	ADIE(1)	CCP1IE(1)	C2IE	C1IE	—	TMR2IE(1)	TMR1IE	-000 0-00	-000 0-00
PIR1	—	ADIF(1)	CCP1IF(1)	C2IF	C1IF	—	TMR2IF(1)	TMR1IF	-000 0-00	-000 0-00
TMR1H	Holding Register for the Most Significant Byte of the 16-bit TMR1 Register								xxxx xxxx	uuuu uuuu
TMR1L	Holding Register for the Least Significant Byte of the 16-bit TMR1 Register								xxxx xxxx	uuuu uuuu
T1CON	T1GINV	TMR1GE	T1CKPS1	T1CKPS0	T1OSCEN	$\overline{\text{T1SYNC}}$	TMR1CS	TMR1ON	0000 0000	uuuu uuuu

Legend: x = unknown, u = unchanged, – = unimplemented, read as '0'. Shaded cells are not used by the Timer1 module.
Note 1: PIC16F616/16HV616 only.

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8.11 Comparator Voltage Reference

The comparator voltage reference module provides an internally generated voltage reference for the comparators. The following features are available:

- Independent from Comparator operation
- Two 16-level voltage ranges
- Output clamped to VSS
- Ratiometric with VDD
- Fixed Reference (0.6V)

The VRCON register (Register 8-6) controls the voltage reference module shown in Figure 8-9.

8.11.1 INDEPENDENT OPERATION

The comparator voltage reference is independent of the comparator configuration. Setting the FVREN bit of the VRCON register will enable the voltage reference.

8.11.2 OUTPUT VOLTAGE SELECTION

The CVREF voltage reference has 2 ranges with 16 voltage levels in each range. Range selection is controlled by the VRR bit of the VRCON register. The 16 levels are set with the VR<3:0> bits of the VRCON register.

The CVREF output voltage is determined by the following equations:

EQUATION 8-1: CVREF OUTPUT VOLTAGE

$$\begin{aligned} &VRR = 1 \text{ (low range):} \\ &\quad CVREF = (VR<3:0>/24) \times VDD \\ &VRR = 0 \text{ (high range):} \\ &\quad CVREF = (VDD/4) + (VR<3:0> \times VDD/32) \end{aligned}$$

The full range of VSS to VDD cannot be realized due to the construction of the module. See Figure 8-9.

8.11.3 OUTPUT CLAMPED TO VSS

The fixed voltage reference output voltage can be set to Vss with no power consumption by clearing the FVREN bit of the VRCON register (FVREN = 0). This allows the comparator to detect a zero-crossing while not consuming additional module current.

8.11.4 OUTPUT RATIOMETRIC TO VDD

The comparator voltage reference is VDD derived and therefore, the CVREF output changes with fluctuations in VDD. The tested absolute accuracy of the Comparator Voltage Reference can be found in **Section 15.0 "Electrical Specifications"**.

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9.0 ANALOG-TO-DIGITAL CONVERTER (ADC) MODULE (PIC16F616/16HV616 ONLY)

The Analog-to-Digital Converter (ADC) allows conversion of an analog input signal to a 10-bit binary representation of that signal. This device uses analog inputs, which are multiplexed into a single sample and hold circuit. The output of the sample and hold is connected to the input of the converter. The converter generates a 10-bit binary result via successive approximation and stores the conversion result into the ADC result registers (ADRESL and ADRESH).

The ADC voltage reference is software selectable to either VDD or a voltage applied to the external reference pins.

The ADC can generate an interrupt upon completion of a conversion. This interrupt can be used to wake-up the device from Sleep.

Figure 9-1 shows the block diagram of the ADC.

Note:	The ADRESL and ADRESH registers are read-only.

FIGURE 9-1: ADC BLOCK DIAGRAM

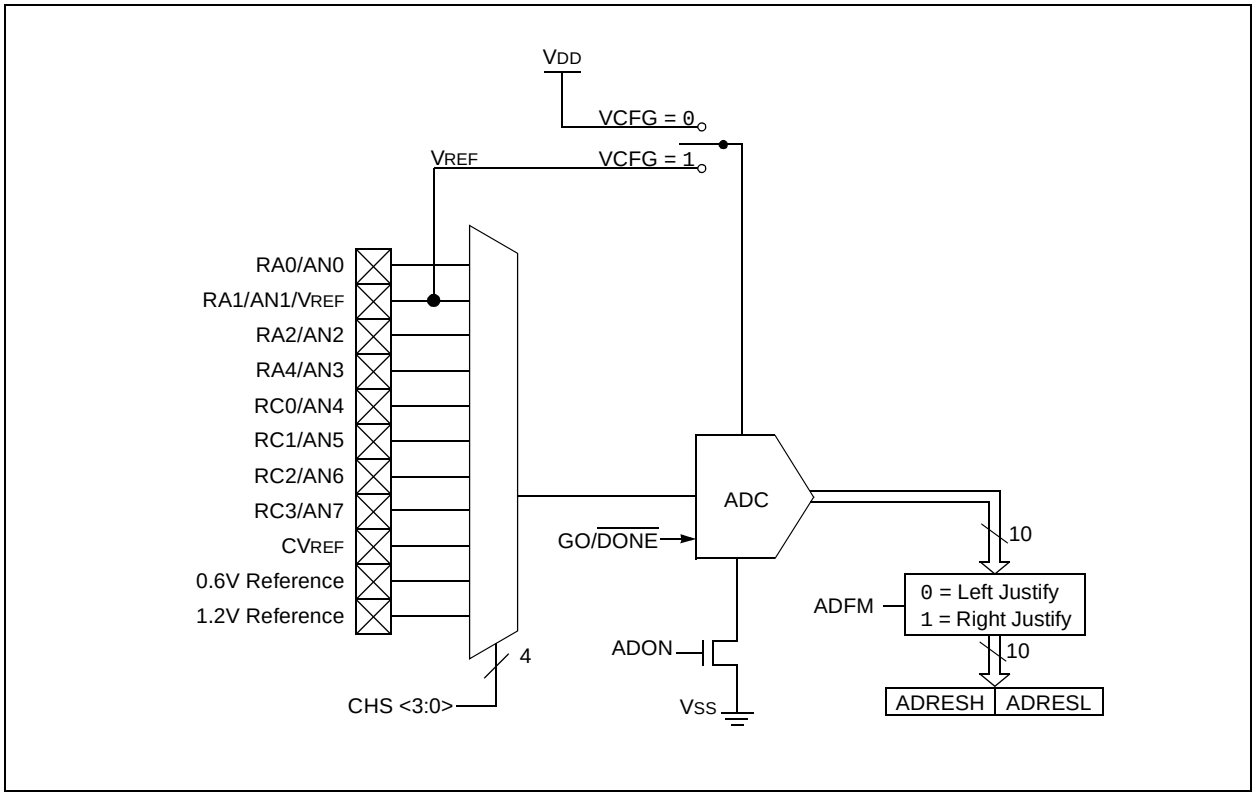


TABLE 9-2: SUMMARY OF ASSOCIATED ADC REGISTERS

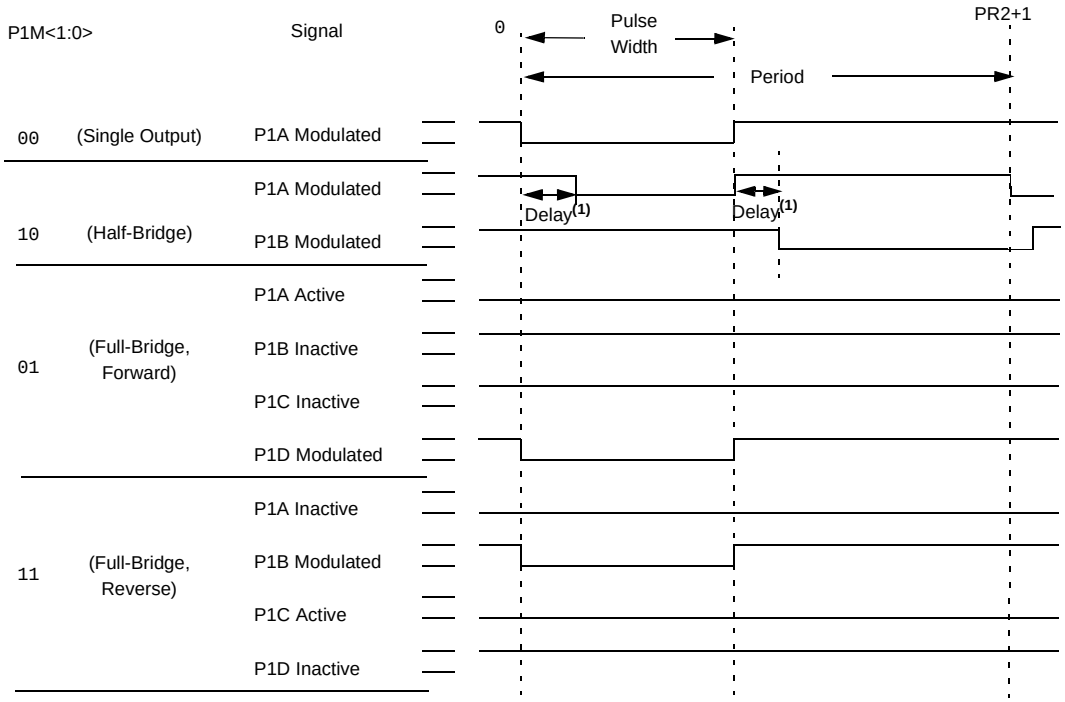
Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Value on all other Resets
ADCON0(1)	ADFM	VCFG	CHS3	CHS2	CHS1	CHS0	GO/$\overline{\text{DONE}}$	ADON	0000 0000	0000 0000
ADCON1(1)	—	ADCS2	ADCS1	ADCS0	—	—	—	—	-000 ----	-000 ----
ANSEL	ANS	ANS6	ANS5	ANS4	ANS3(1)	ANS2(1)	ANS1	ANS0	1111 1111	1111 1111
ADRESH(1,2)	A/D Result Register High Byte								xxxx xxxx	uuuu uuuu
ADRESL(1,2)	A/D Result Register Low Byte								xxxx xxxx	uuuu uuuu
INTCON	GIE	PEIE	T0IE	INTE	RAIE	T0IF	INTF	RAIF	0000 0000	0000 0000
PIE1	—	ADIE(1)	CCP1IE(1)	C2IE	C1IE	—	TMR2IE(1)	TMR1IE	-000 0-00	-000 0-00
PIR1	—	ADIF(1)	CCP1IF(1)	C2IF	C1IF	—	TMR2IF(1)	TMR1IF	-000 0-00	-000 0-00
PORTA	—	—	RA5	RA4	RA3	RA2	RA1	RA0	--x0 x000	--u0 u000
PORTC	—	—	RC5	RC4	RC3	RC2	RC1	RC0	--xx 00xx	--uu 00uu
TRISA	—	—	TRISA5	TRISA4	TRISA3	TRISA2	TRISA1	TRISA0	--11 1111	--11 1111
TRISC	—	—	TRISC5	TRISC4	TRISC3	TRISC2	TRISC1	TRISC0	--11 1111	--11 1111

Legend: x = unknown, u = unchanged, – = unimplemented read as '0'. Shaded cells are not used for ADC module.

Note 1: PIC16F616/16HV616 only.

2: Read-only Register.

FIGURE 10-7: EXAMPLE ENHANCED PWM OUTPUT RELATIONSHIPS (ACTIVE-LOW STATE)



Relationships:

- Period = 4 * Tosc * (PR2 + 1) * (TMR2 Prescale Value)
- Pulse Width = Tosc * (CCPR1L<7:0>:CCP1CON<5:4>) * (TMR2 Prescale Value)
- Delay = 4 * Tosc * (PWM1CON<6:0>)

Note 1: Dead-band delay is programmed using the PWM1CON register (**Section 10.4.6 "Programmable Dead-Band Delay mode"**).

TABLE 13-2: PIC16F610/616/16HV610/616 INSTRUCTION SET

Mnemonic, Operands		Description	Cycles	14-Bit Opcode				Status Affected	Notes
				MSb			LSb		
BYTE-ORIENTED FILE REGISTER OPERATIONS									
ADDWF	f, d	Add W and f	1	00	0111	dfff	ffff	C, DC, Z	**1, 2**
ANDWF	f, d	AND W with f	1	00	0101	dfff	ffff	Z	**1, 2**
CLRF	f	Clear f	1	00	0001	lfff	ffff	Z	**2**
CLRW	–	Clear W	1	00	0001	0xxx	xxxx	Z	
COMF	f, d	Complement f	1	00	1001	dfff	ffff	Z	**1, 2**
DECF	f, d	Decrement f	1	00	0011	dfff	ffff	Z	**1, 2**
DECFSZ	f, d	Decrement f, Skip if 0	1**(2)**	00	1011	dfff	ffff		**1, 2, 3**
INCF	f, d	Increment f	1	00	1010	dfff	ffff	Z	**1, 2**
INCFSZ	f, d	Increment f, Skip if 0	1**(2)**	00	1111	dfff	ffff		**1, 2, 3**
IORWF	f, d	Inclusive OR W with f	1	00	0100	dfff	ffff	Z	**1, 2**
MOVF	f, d	Move f	1	00	1000	dfff	ffff	Z	**1, 2**
MOVWF	f	Move W to f	1	00	0000	lfff	ffff		
NOP	–	No Operation	1	00	0000	0xx0	0000		
RLF	f, d	Rotate Left f through Carry	1	00	1101	dfff	ffff	C	**1, 2**
RRF	f, d	Rotate Right f through Carry	1	00	1100	dfff	ffff	C	**1, 2**
SUBWF	f, d	Subtract W from f	1	00	0010	dfff	ffff	C, DC, Z	**1, 2**
SWAPF	f, d	Swap nibbles in f	1	00	1110	dfff	ffff		**1, 2**
XORWF	f, d	Exclusive OR W with f	1	00	0110	dfff	ffff	Z	**1, 2**
BIT-ORIENTED FILE REGISTER OPERATIONS									
BCF	f, b	Bit Clear f	1	01	00bb	bfff	ffff		**1, 2**
BSF	f, b	Bit Set f	1	01	01bb	bfff	ffff		**1, 2**
BTFSC	f, b	Bit Test f, Skip if Clear	1 **(2)**	01	10bb	bfff	ffff		**3**
BTFSS	f, b	Bit Test f, Skip if Set	1 **(2)**	01	11bb	bfff	ffff		**3**
LITERAL AND CONTROL OPERATIONS									
ADDLW	k	Add literal and W	1	11	111x	kkkk	kkkk	C, DC, Z	
ANDLW	k	AND literal with W	1	11	1001	kkkk	kkkk	Z	
CALL	k	Call Subroutine	2	10	0kkk	kkkk	kkkk		
CLRWDT	–	Clear Watchdog Timer	1	00	0000	0110	0100	$\overline{TO}$, $\overline{PD}$	
GOTO	k	Go to address	2	10	1kkk	kkkk	kkkk		
IORLW	k	Inclusive OR literal with W	1	11	1000	kkkk	kkkk	Z	
MOVLW	k	Move literal to W	1	11	00xx	kkkk	kkkk		
RETFIE	–	Return from interrupt	2	00	0000	0000	1001		
RETLW	k	Return with literal in W	2	11	01xx	kkkk	kkkk		
RETURN	–	Return from Subroutine	2	00	0000	0000	1000		
SLEEP	–	Go into Standby mode	1	00	0000	0110	0011	$\overline{TO}$, $\overline{PD}$	
SUBLW	k	Subtract W from literal	1	11	110x	kkkk	kkkk	C, DC, Z	
XORLW	k	Exclusive OR literal with W	1	11	1010	kkkk	kkkk	Z	

Note 1: When an I/O register is modified as a function of itself (e.g., `MOVF PORTA, 1`), the value used will be that value present on the pins themselves. For example, if the data latch is '1' for a pin configured as input and is driven low by an external device, the data will be written back with a '0'.

2: If this instruction is executed on the TMR0 register (and where applicable, d = 1), the prescaler will be cleared if assigned to the Timer0 module.

3: If the Program Counter (PC) is modified, or a conditional test is true, the instruction requires two cycles. The second cycle is executed as a `NOP`.

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15.2 DC Characteristics: PIC16F610/616-I (Industrial) PIC16F610/616-E (Extended)

DC CHARACTERISTICS		Standard Operating Conditions (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for industrial -40°C ≤ TA ≤ +125°C for extended					
Param No.	Device Characteristics	Min	Typ†	Max	Units	Conditions	
						VDD	Note
D010	**Supply Current (IDD)(1, 2)** PIC16F610/616	—	13	25	µA	2.0	FOSC = 32 kHz LP Oscillator mode
		—	19	29	µA	3.0	
		—	32	51	µA	5.0	
D011*		—	135	225	µA	2.0	FOSC = 1 MHz XT Oscillator mode
		—	185	285	µA	3.0	
		—	300	405	µA	5.0	
D012		—	240	360	µA	2.0	FOSC = 4 MHz XT Oscillator mode
		—	360	505	µA	3.0	
		—	0.66	1.0	mA	5.0	
D013*		—	75	110	µA	2.0	FOSC = 1 MHz EC Oscillator mode
		—	155	255	µA	3.0	
		—	345	530	µA	5.0	
D014		—	185	255	µA	2.0	FOSC = 4 MHz EC Oscillator mode
		—	325	475	µA	3.0	
		—	0.665	1.0	mA	5.0	
D016*		—	245	340	µA	2.0	FOSC = 4 MHz INTOSC mode
		—	360	485	µA	3.0	
		—	0.620	0.845	mA	5.0	
D017		—	395	550	µA	2.0	FOSC = 8 MHz INTOSC mode
		—	0.620	0.850	mA	3.0	
		—	1.2	1.6	mA	5.0	
D018		—	175	235	µA	2.0	FOSC = 4 MHz EXTRC mode(3)
		—	285	390	µA	3.0	
		—	530	750	µA	5.0	
D019		—	2.2	3.1	mA	4.5	FOSC = 20 MHz HS Oscillator mode
		—	2.8	3.35	mA	5.0	

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: The test conditions for all IDD measurements in active operation mode are: OSC1 = external square wave, from rail-to-rail; all I/O pins tri-stated, pulled to VDD; $\overline{MCLR}$ = VDD; WDT disabled.

2: The supply current is mainly a function of the operating voltage and frequency. Other factors, such as I/O pin loading and switching rate, oscillator type, internal code execution pattern and temperature, also have an impact on the current consumption.

3: For RC oscillator configurations, current through REXT is not included. The current through the resistor can be extended by the formula IR = VDD/2REXT (mA) with REXT in kΩ.

15.10 Thermal Considerations

Standard Operating Conditions (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +125°C					
Param No.	**Sym**	**Characteristic**	**Typ**	**Units**	**Conditions**
TH01	θJA	Thermal Resistance Junction to Ambient	70*	C/W	14-pin PDIP package
			85.0*	C/W	14-pin SOIC package
			100*	C/W	14-pin TSSOP package
			37*	C/W	16-pin QFN 4x4mm package
TH02	θJC	Thermal Resistance Junction to Case	32.5*	C/W	14-pin PDIP package
			31.0*	C/W	14-pin SOIC package
			31.7*	C/W	14-pin TSSOP package
			2.6*	C/W	16-pin QFN 4x4mm package
TH03	TDIE	Die Temperature	150*	C	
TH04	PD	Power Dissipation	—	W	PD = PINTERNAL + PI/O
TH05	PINTERNAL	Internal Power Dissipation	—	W	PINTERNAL = IDD x VDD **(NOTE 1)**
TH06	PI/O	I/O Power Dissipation	—	W	PI/O = Σ (IOL * VOL) + Σ (IOH * (VDD - VOH))
TH07	PDER	Derated Power	—	W	PDER = PDMAX (TDIE - TA)/θJA **(NOTE 2)**

* These parameters are characterized but not tested.

Note 1: IDD is current to run the chip alone without driving any load on the output pins.

2: TA = Ambient Temperature.

TABLE 15-7: COMPARATOR SPECIFICATIONS

Standard Operating Conditions (unless otherwise stated) Operating Temperature -40°C ≤ TA ≤ +125°C								
Param No.	**Sym**	**Characteristics**		**Min**	**Typ†**	**Max**	**Units**	**Comments**
CM01	VOS	Input Offset Voltage(2)		—	± 5.0	± 10	mV	
CM02	VCM	Input Common Mode Voltage		0	—	VDD – 1.5	V	
CM03*	CMRR	Common Mode Rejection Ratio		+55	—	—	dB	
CM04*	TRT	Response Time(1)	Falling	—	150	600	ns	
			Rising	—	200	1000	ns	
CM05*	TMC2COV	Comparator Mode Change to Output Valid		—	—	10	µs	
CM06*	VHYS	Input Hysteresis Voltage		—	45	60	mV	

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: Response time is measured with one comparator input at (VDD - 1.5)/2 - 100 mV to (VDD - 1.5)/2 + 20 mV. The other input is at (VDD -1.5)/2.

2: Input offset voltage is measured with one comparator input at (VDD - 1.5V)/2.

TABLE 15-8: COMPARATOR VOLTAGE REFERENCE (CVREF) SPECIFICATIONS

Standard Operating Conditions (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +125°C							
Param No.	**Sym**	**Characteristics**	**Min**	**Typ†**	**Max**	**Units**	**Comments**
CV01	CLSB	Step Size(2)	— —	VDD/24 VDD/32	— —	V V	Low Range (VRR = 1) High Range (VRR = 0)
CV02	CACC	Absolute Accuracy(3)	— —	— —	± 1/2 ± 1/2	LSb LSb	Low Range (VRR = 1) High Range (VRR = 0)
CV03	CR	Unit Resistor Value (R)	—	2k	—	Ω	
CV04	CST	Settling Time(1)	—	—	10	µs	

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: Settling time measured while VRR = 1 and VR<3:0> transitions from '0000' to '1111'.

2: See **Section 8.11 "Comparator Voltage Reference"** for more information.

3: Absolute Accuracy when CVREF output is ≤ (VDD-1.5).

TABLE 15-9: VOLTAGE REFERENCE SPECIFICATIONS

VR Voltage Reference Specifications			**Standard Operating Conditions (unless otherwise stated)** Operating temperature -40°C ≤ TA ≤ +125°C				
Param No.	**Symbol**	**Characteristics**	**Min**	**Typ**	**Max**	**Units**	**Comments**
VR01	VP6OUT	VP6 voltage output	0.50	0.6	0.7	V	
VR02	V1P2OUT	V1P2 voltage output	1.05	1.20	1.35	V	
VR03*	TSTABLE	Settling Time	—	10	—	µs	

* These parameters are characterized but not tested.

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TABLE 15-10: SHUNT REGULATOR SPECIFICATIONS (PIC16HV610/616 only)

SHUNT REGULATOR CHARACTERISTICS			Standard Operating Conditions (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +125°C				
Param No.	**Symbol**	**Characteristics**	**Min**	**Typ**	**Max**	**Units**	**Comments**
SR01	VSHUNT	Shunt Voltage	4.75	5	5.4	V	
SR02	ISHUNT	Shunt Current	4	—	50	mA	
SR03*	TSETTLE	Settling Time	—	—	150	ns	To 1% of final value
SR04	CLOAD	Load Capacitance	0.01	—	10	µF	Bypass capacitor on VDD pin
SR05	ΔISNT	Regulator operating current	—	180	—	µA	Includes band gap reference current

* These parameters are characterized but not tested.

TABLE 15-11: PIC16F616/16HV616 A/D CONVERTER (ADC) CHARACTERISTICS:

Standard Operating Conditions (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +125°C							
Param No.	**Sym**	**Characteristic**	**Min**	**Typ†**	**Max**	**Units**	**Conditions**
AD01	NR	Resolution	—	—	10 bits	bit	
AD02	EIL	Integral Error	—	—	±1	LSb	VREF = 5.12V**(5)**
AD03	EDL	Differential Error	—	—	±1	LSb	No missing codes to 10 bits VREF = 5.12V**(5)**
AD04	EOFF	Offset Error	—	+1.5	+ 2.0	LSb	VREF = 5.12V**(5)**
AD07	EGN	Gain Error	—	—	±1	LSb	VREF = 5.12V**(5)**
AD06 AD06A	VREF	Reference Voltage**(3)**	2.2 2.5	—	— VDD	V	 Absolute minimum to ensure 1 LSb accuracy
AD07	VAIN	Full-Scale Range	VSS	—	VREF	V	
AD08	ZAIN	Recommended Impedance of Analog Voltage Source	—	—	10	kΩ	
AD09*	IREF	VREF Input Current**(3)**	10	—	1000	µA	During VAIN acquisition. Based on differential of VHOLD to VAIN.
			—	—	50	µA	During A/D conversion cycle.

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: Total Absolute Error includes integral, differential, offset and gain errors.

2: The A/D conversion result never decreases with an increase in the input voltage and has no missing codes.

3: ADC VREF is from external VREF or VDD pin, whichever is selected as reference input.

4: When ADC is off, it will not consume any current other than leakage current. The power-down current specification includes any such leakage from the ADC module.

5: VREF = 5V for PIC16HV616.

TABLE 15-15: DC CHARACTERISTICS FOR I_{PD} SPECIFICATIONS FOR PIC16F616 – H (High Temp.)

Param No.	Device Characteristics	Units	Min	Typ	Max	Condition	
						V_{DD}	Note
D020E	Power Down I_{PD}	µA	—	0.05	12	2.0	I_{PD} Base
			—	0.15	13	3.0	
			—	0.35	14	5.0	
D021E		µA	—	0.5	20	2.0	WDT Current
			—	2.5	25	3.0	
			—	9.5	36	5.0	
D022E		µA	—	5.0	28	3.0	BOR Current
			—	6.0	36	5.0	
D023E		µA	—	105	195	2.0	I_{PD} Current (Both Comparators Enabled)
			—	110	210	3.0	
			—	116	220	5.0	
		µA	—	50	105	2.0	I_{PD} Current (One Comparator Enabled)
			—	55	110	3.0	
			—	60	125	5.0	
D024E		µA	—	30	58	2.0	I_{PD} (C_{VREF}, High Range)
			—	45	85	3.0	
			—	75	142	5.0	
D025E		µA	—	39	76	2.0	I_{PD} (C_{VREF}, Low Range)
			—	59	114	3.0	
			—	98	190	5.0	
D026E		µA	—	5.5	30	2.0	I_{PD} (T1 OSC, 32 kHz)
			—	7.0	35	3.0	
			—	8.5	45	5.0	
D027E		µA	—	0.2	12	3.0	I_{PD} (A2D on, not converting)
			—	0.3	15	5.0	

TABLE 15-16: WATCHDOG TIMER SPECIFICATIONS FOR PIC16F616 – H (High Temp.)

Param No.	Sym	Characteristic	Units	Min	Typ	Max	Conditions
31	T_{WDT}	Watchdog Timer Time-out Period (No Prescaler)	ms	6	20	70	150°C Temperature

TABLE 15-17: LEAKAGE CURRENT SPECIFICATIONS FOR PIC16F616 – H (High Temp.)

Param No.	Sym	Characteristic	Units	Min	Typ	Max	Conditions
D061	I_{IL}	Input Leakage Current(1) (GP3/RA3/$\overline{MCLR}$)	µA	—	±0.5	±5.0	$V_{SS} \le V_{PIN} \le V_{DD}$
D062	I_{IL}	Input Leakage Current(2) (GP3/RA3/$\overline{MCLR}$)	µA	50	250	400	V_{DD} = 5.0V

Note 1: This specification applies when GP3/RA3/$\overline{MCLR}$ is configured as an input with the pull-up disabled. The leakage current for the GP3/RA3/$\overline{MCLR}$ pin is higher than for the standard I/O port pins.

2: This specification applies when GP3/RA3/$\overline{MCLR}$ is configured as the $\overline{MCLR}$ Reset pin function with the weak pull-up enabled.

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TABLE 15-18: OSCILLATOR PARAMETERS FOR PIC16F616 – H (High Temp.)

Param No.	Sym	Characteristic	Frequency Tolerance	Units	Min	Typ	Max	Conditions
OS08	INTOSC	Int. Calibrated INTOSC Freq.(1)	±10%	MHz	7.2	8.0	8.8	2.0V ≤ VDD ≤ 5.5V -40°C ≤ TA ≤ 150°C

Note 1: To ensure these oscillator frequency tolerances, VDD and VSS must be capacitively decoupled as close to the device as possible. 0.1 µF and 0.01 µF values in parallel are recommended.

TABLE 15-19: COMPARATOR SPECIFICATIONS FOR PIC16F616 – H (High Temp.)

Param No.	Sym	Characteristic	Units	Min	Typ	Max	Conditions
CM01	VOS	Input Offset Voltage	mV	—	±5	±20	(VDD - 1.5)/2

FIGURE 16-39: VOH VS. IOH OVER TEMPERATURE (VDD = 5.0V)

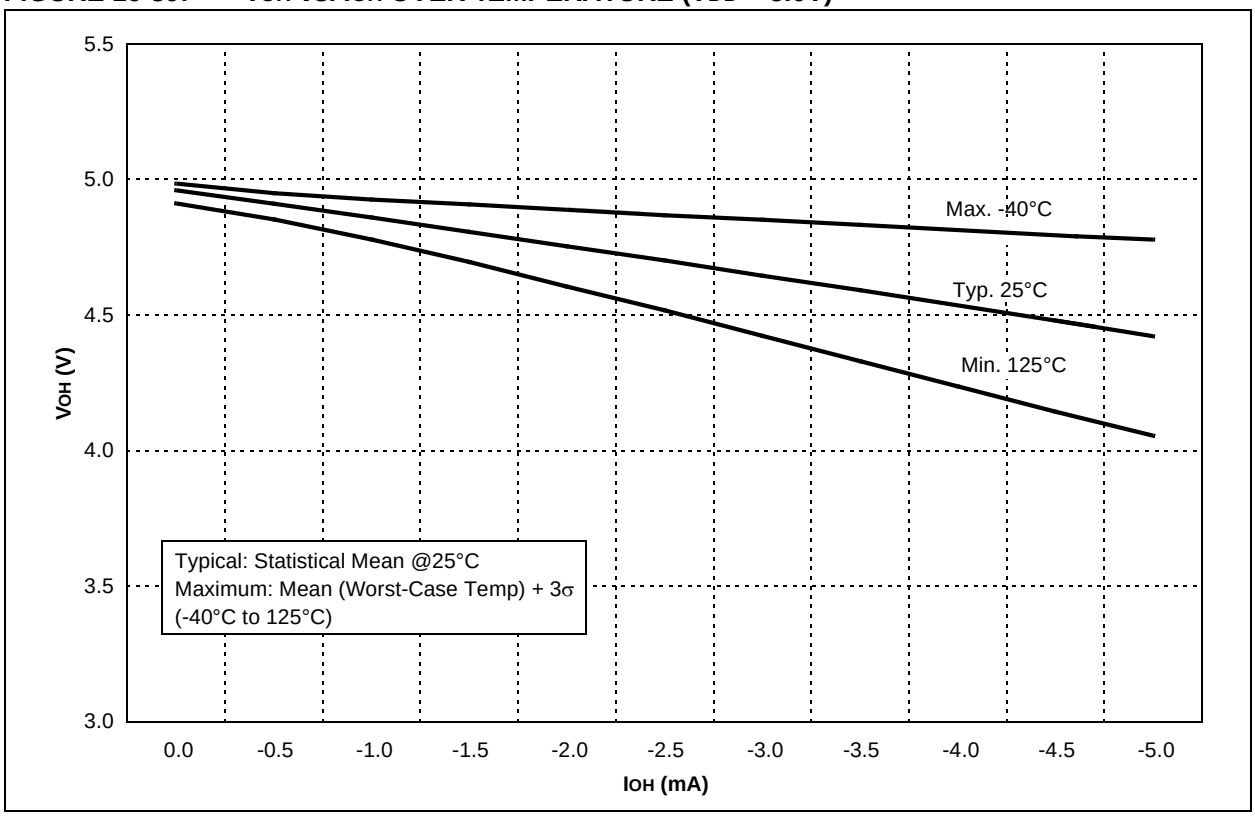


FIGURE 16-40: TTL INPUT THRESHOLD VIN VS. VDD OVER TEMPERATURE

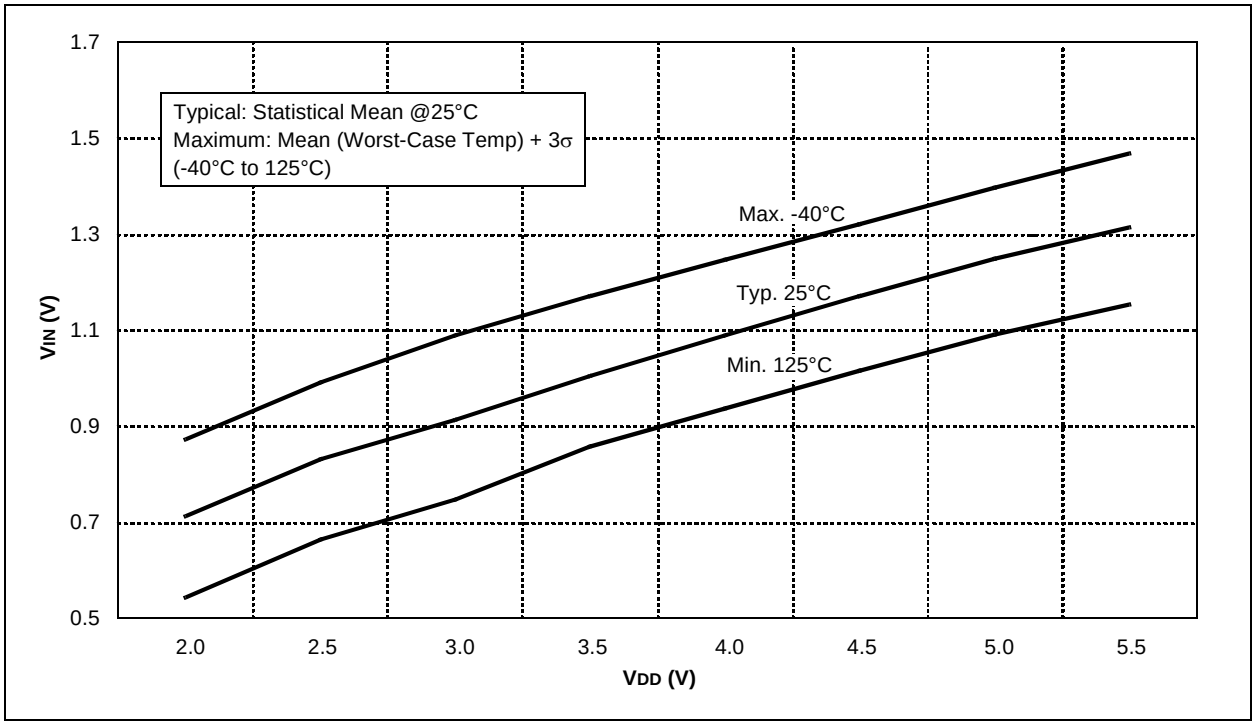


FIGURE 16-54: COMPARATOR RESPONSE TIME (FALLING EDGE)

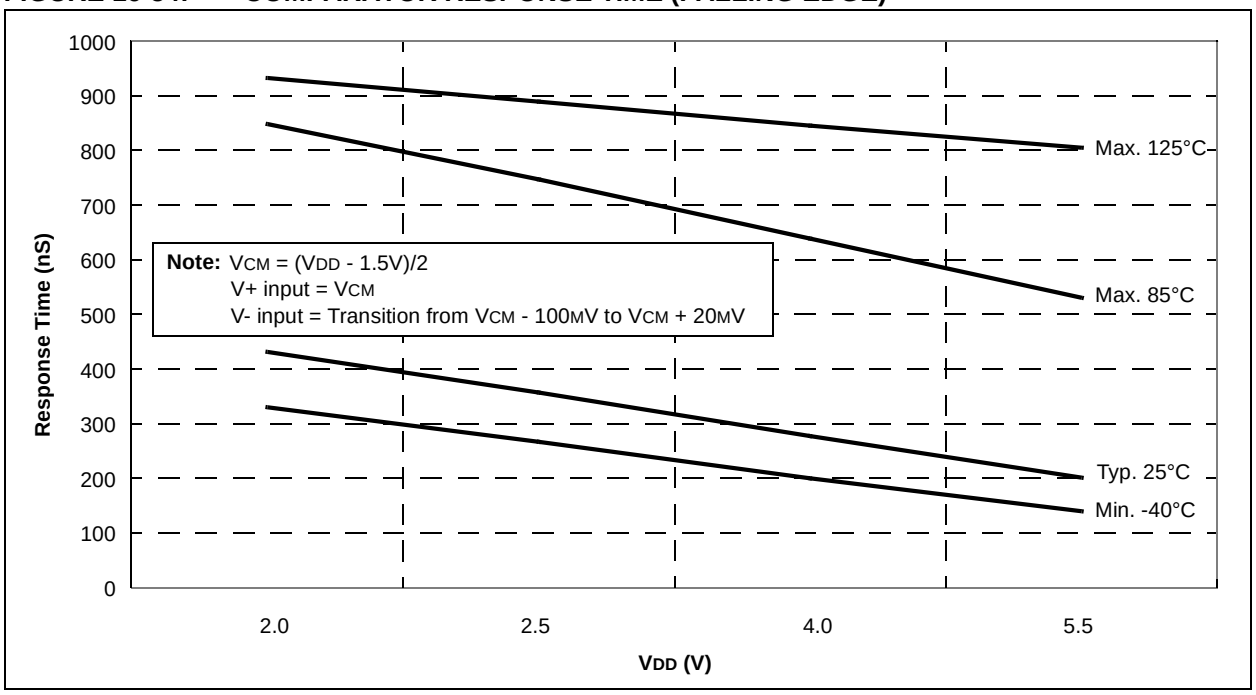
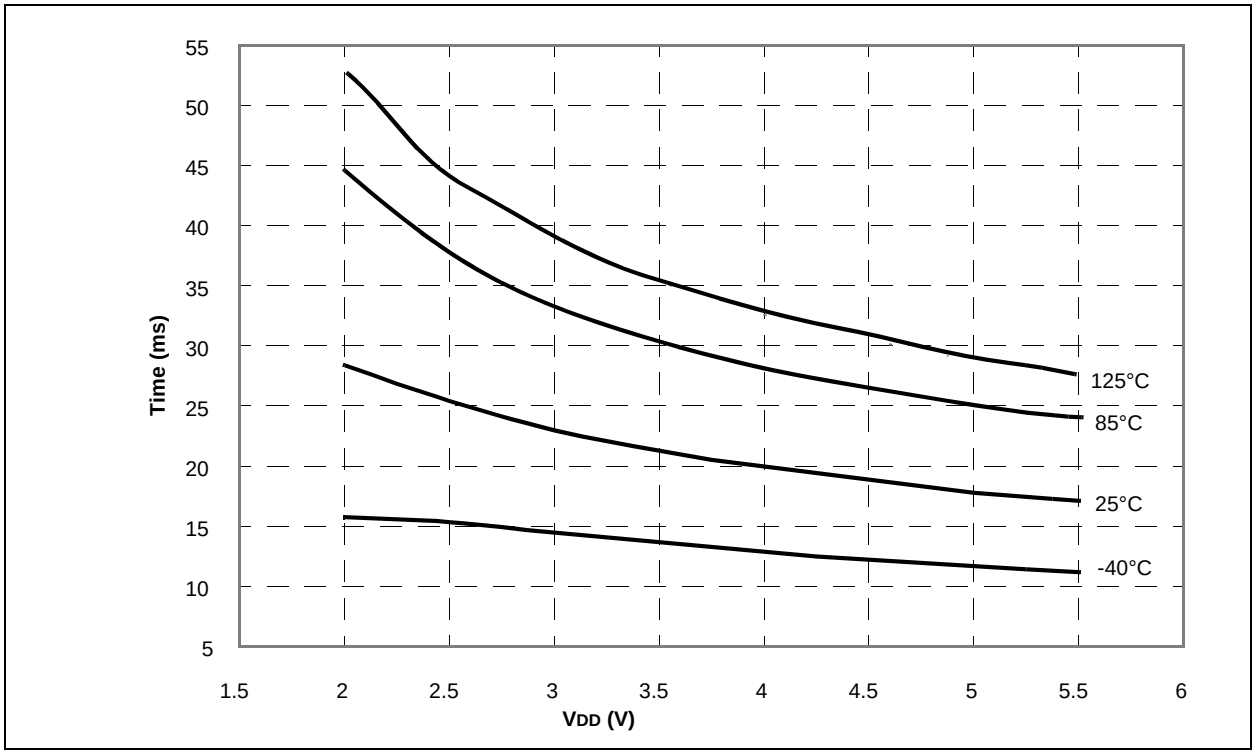


FIGURE 16-55: WDT TIME-OUT PERIOD vs. VDD OVER TEMPERATURE



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APPENDIX A: DATA SHEET REVISION HISTORY

Revision A

This is a new data sheet.

Revision B (12/06)

Added PIC16F610/16HV610 parts.
Replaced Package Drawings.

Revision C (03/2007)

Replaced Package Drawings (Rev. AM); Replaced Development Support Section; Revised Product ID System.

Revision D (06/2008)

Added Graphs; Revised 28-Pin ICD Pinout, Electrical Specifications Section; Package Details.

Revision E (09/2009)

Added section 15.13 (High Temperature Operation) to the Electrical Specifications Chapter; Other minor corrections.

Revision F (11/2009)

Updated Figure 16-52.